

SOLDERING CONDITIONS:

ALL RIGHTS RESERVED

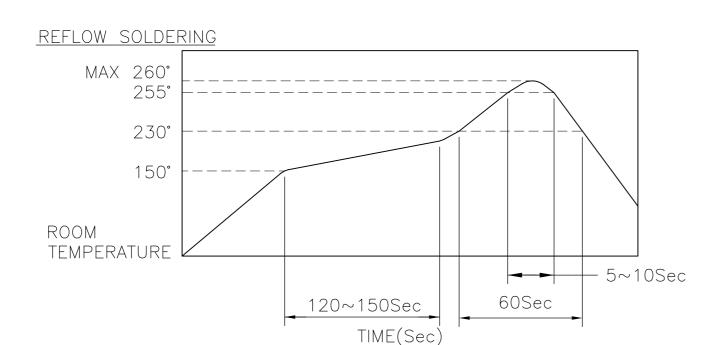
THE CONDITIONS MENTIONED BELOW IS THE TEMPERATURE ON THE CU FOIL OF THE P.C.B SURFACE. DO NOT ALLOW THE SWITCH'S SURFACE TEMPERATURE TO EXCEED 260°C.

MANUAL SOLDERING

THIS DRAWING IS UNPUBLISHED.

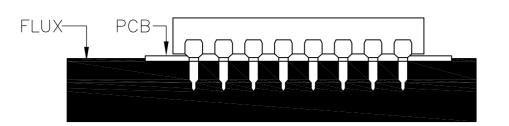
C COPYRIGHT - TE Connectivity

SOLDERING TEMPERATURE	MAX. 350°C.
CONTINUOUS SOLDERING TIME	MAX. 5 SECONDS.



HANDLING PRECAUTIONS

- 1. CARE SHOULD BE EXERCISED SO THAT FLUX FROM THE UPPER PART OF THE PRINTED CIRCUIT BOARD DOES NOT ADHERE TO THE SWITCH.
- 2. DON'T CLEAN THE SWITCH BODY EXCEPT WITH TOP TAPE SEALED TYPE, WHICH CAN ONLY SPRAY OF CLEANING METHOD FROM TOP OF S/W.
- 3. ENSURE FLUX DOES NOT RISE ABOVE THE TOP SURFACE OF THE PCB.



SPECIFICATIONS:

MATERIALS:

BASE: PA (HIGH-TEMP. NYLON) UL94V-O COVER: PA (HIGH-TEMP. NYLON) UL94V-O

ACTUATOR: LCP UL94V-0

CONTACT: COPPER ALLOY, GOLD (in contact area)

SEE SHEET 1

OVER NICKEL PLATE

TERMINAL: BRASS ALLOY, GOLD PLATE

TAPE:POLYAMIDE.

ELECTRICAL:

CONTACT RATING: NON-SWITCHING 100mA @ 50 VDC.

SWITCHING: 25mA @ 24 VDC.

INITIAL CONTACT RESISTANCE: $100m\Omega$ MAX. @ 2 VDC. 10mA. INSULATION RESISTANCE: 100 MEGOHMS MIN. @ 500 VDC, 1 MINUTE +/- 5 SECONDS.

DIELECTRIC STRENGTH: 500 VAC (50 OR 60 HZ), 1 MINUTE.

DURABILITY: 2,000 CYCLES.

CAPACITANCE: 5 pF MAX @ 1 MHz +/- 10 KHz.

MECHANICAL:

OPERATING FORCE: 1000gf MAX.

ENVIRONMENTAL:

OPERATING TEMPERATURE: -20°C TO +85°C. STORAGE TEMPERATURE: -40°C TO +85°C.

SOLDER HEAT RESISTANCE PER 109-201, CONDITION B. SOLDERABILITY PER JIS C 0050 & JIS C 0053.

IOTES:

1 ALL MATERIALS AND FINISHES SHALL COMPLY WITH EU DIRECTIVE 2002/95/EC OF 27 JAN 2003 (ROHS).



TUBE PACKAGING.

3

TAPE AND REEL PACKAGING.

THIS DRAWING IS A CONTROLLED DOCUMENT. SHIVAKUMAR S S ETE. TE Connectivity PVD 29MAY2017 ALEXANDER SHARPE mm[INCHES] END STACKABLE DIP SWITCHES PRODUCT SPEC RAISED ACTUATOR ± 0.20[.008] APPLICATION SPEC SIZE | CAGE CODE | DRAWING NO RESTRICTED TO 2 00779 **C**-2319847 MATERIAL CUSTOMER DRAWING 4 OF 4

1471-9 (1/15)

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